

N-channel 30 V, 0.87 m $\Omega$ , 300 A logic level MOSFET in SOT1023A enhanced package for UL2595, using NextPowerS3 Schottky-Plus Technology

22 December 2017

**Product data sheet** 

#### 1. General description

SOT1023A with improved creepage and clearance to meet UL2595 requirements. 300 Amp logic level gate drive N-channel enhancement mode MOSFET in LFPAK56 package. NextPowerS3 portfolio utilising Nexperia's unique "SchottkyPlus" technology delivers high efficiency, low spiking performance usually associated with MOSFETs with an integrated Schottky or Schottky-like diode but without problematic high leakage current. NextPowerS3 is particularly suited to high efficiency applications at high switching frequencies.

#### 2. Features and benefits

- Improved creepage and clearance meets the requirements of UL2595
- 300 A capability
- Avalanche rated, 100% tested at I<sub>AS</sub> = 190 A
- Ultra low Q<sub>G</sub>, Q<sub>GD</sub> and Q<sub>OSS</sub> for high system efficiency, especially at higher switching frequencies
- Superfast switching with soft-recovery; s-factor > 1
- Low spiking and ringing for low EMI designs
- Unique "SchottkyPlus" technology; Schottky-like performance with < 1 µA leakage at 25 °C</li>
- Optimised for 4.5 V gate drive
- · Low parasitic inductance and resistance
- High reliability clip bonded and solder die attach Power SO8 package; no glue, no wire bonds, qualified to 150 °C
- · Wave solderable; exposed leads for optimal visual solder inspection

#### 3. Applications

- Brushed and brushless motor control
- Battery powered appliances where enhanced creepage and clearance is required to meet UL2595
- For non-UL2595 applications please use PSMN0R9-30YLD

#### 4. Quick reference data

Table 1. Qui	able 1. Quick reference data						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 150 °C		-	-	30	V
I <sub>D</sub>	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; <u>Fig. 2</u>	[1]	-	-	300	А
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 1</u>		-	-	227	W
Tj	junction temperature			-55	-	150	°C

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Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Static chara	acteristics		1			
R <sub>DSon</sub> drain-source on-state resistance		V <sub>GS</sub> = 4.5 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; Fig. 10	-	0.79	1.09	mΩ
	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	-	0.65	0.87	mΩ	
Dynamic ch	naracteristics		1			-
Q <sub>GD</sub>	gate-drain charge	I <sub>D</sub> = 25 A; V <sub>DS</sub> = 15 V; V <sub>GS</sub> = 4.5 V; Fig. 12; Fig. 13	-	13.5	-	nC
Q <sub>G(tot)</sub>	total gate charge	I <sub>D</sub> = 25 A; V <sub>DS</sub> = 15 V; V <sub>GS</sub> = 10 V; Fig. 12; Fig. 13	-	109	-	nC
Source-dra	in diode		1			
S	softness factor	$I_{S}$ = 25 A; dI <sub>S</sub> /dt = -100 A/µs; V <sub>GS</sub> = 0 V; V <sub>DS</sub> = 15 V; Fig. 16	-	0.9	-	

[1] 300A Continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

### 5. Pinning information

Table 2.	Pinning in	formation		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source		D
2	S	source		
3	S	source		G-UF A
4	G	gate		mbb076 S
mb	D	mounting base; connected to drain	LFPAK56; Power- SO8 (SOT1023A)	

### 6. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
PSMN0R9-30ULD	LFPAK56; Power-SO8	plastic, single-ended surface-mounted package (LFPAK56); 4 leads; 1.27 mm pitch; 4.6 mm x 5.1 mm x 1.0 mm body	SOT1023A			

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#### 7. Marking

Table 4. Marking codes				
Type number	Marking code			
PSMN0R9-30ULD	0D93UL			

### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Мах	Unit
V <sub>DS</sub>	drain-source voltage	25 °C ≤ T <sub>j</sub> ≤ 150 °C		-	30	V
V <sub>DGR</sub>	drain-gate voltage	25 °C ≤ $T_j$ ≤ 150 °C; $R_{GS}$ = 20 kΩ		-	30	V
V <sub>GS</sub>	gate-source voltage			-20	20	V
P <sub>tot</sub>	total power dissipation	T <sub>mb</sub> = 25 °C; <u>Fig. 1</u>		-	227	W
I <sub>D</sub> drain curre	drain current	V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 25 °C; <u>Fig. 2</u>	[1]	-	300	А
		V <sub>GS</sub> = 10 V; T <sub>mb</sub> = 100 °C; <u>Fig. 2</u>		-	284	А
I <sub>DM</sub>	peak drain current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^{\circ}C$ ; Fig. 3		-	1592	А
T <sub>stg</sub>	storage temperature			-55	150	°C
Tj	junction temperature			-55	150	°C
T <sub>sld(M)</sub>	peak soldering temperature			-	260	°C
V <sub>ESD</sub>	electrostatic discharge voltage	НВМ		2	-	kV
Source-drai	n diode	·	1			
I <sub>S</sub>	source current	T <sub>mb</sub> = 25 °C		-	242	А
I <sub>SM</sub>	peak source current	pulsed; $t_p \le 10 \ \mu s$ ; $T_{mb} = 25 \ ^{\circ}C$		-	1800	А
Avalanche r	ruggedness	·				
E <sub>DS(AL)S</sub>	non-repetitive drain- source avalanche energy	$I_D$ = 25 A; V <sub>sup</sub> ≤ 30 V; R <sub>GS</sub> = 50 Ω; V <sub>GS</sub> = 10 V; T <sub>j(init)</sub> = 25 °C; unclamped; t <sub>p</sub> = 6.1 ms	[2]	-	2575	mJ
I <sub>AS</sub>	non-repetitive avalanche current	$V_{sup} \le 30 \text{ V}; V_{GS} = 10 \text{ V}; T_{j(init)} = 25 \text{ °C}; R_{GS} = 50 \Omega$	[2]	-	190	A

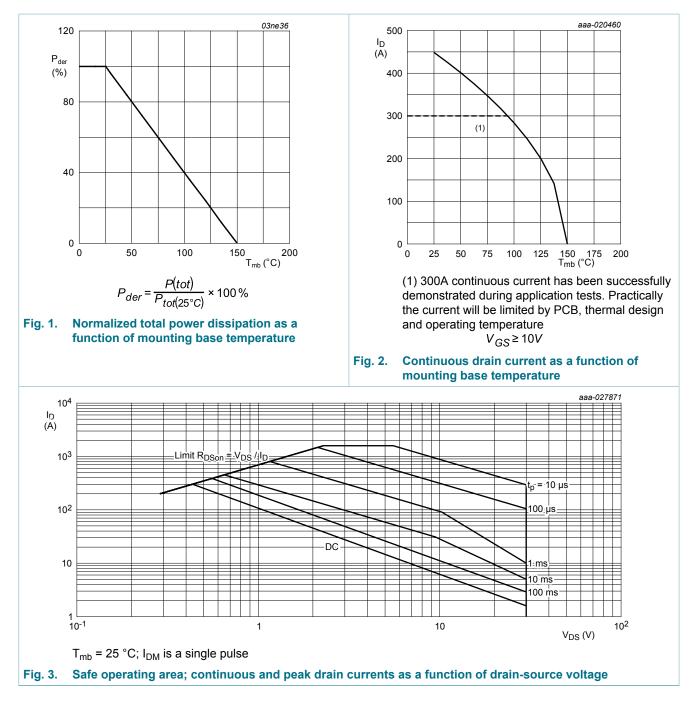
[1] 300A Continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

[2] Protected by 100% test

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#### 9. Thermal characteristics

Table 6. Thermal characteristics							
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
R <sub>th(j-mb)</sub>	thermal resistance from junction to mounting base	Fig. 4		-	0.45	0.55	K/W

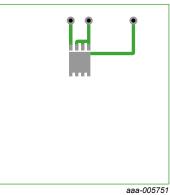
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$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Unit	Max	Тур	Min			ns	Condition	meter	Para	Symbol
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	K/W	-	50	-				Fig. 5			R <sub>th(j-a)</sub>
$Z_{\text{th}(i-m)} = 0.5$ $10^{-1} = 0.5$ $10^{-$	K/W	-	125	-				<u>Fig. 6</u>	from junction to		
b = 0.5		aa-027870	a								1 —
$ \begin{bmatrix} \delta = 0.5 & 0.5 & 0.4$											Z <sub>th(i-mb)</sub>
$10^{-1} \underbrace{0.2}_{0.1} \underbrace{0.1}_{0.05} \underbrace{0.02}_{0.02} \underbrace{10^{-1}}_{\text{single shot}} \underbrace{10^{-1}}_{0.05} \underbrace{10^{-1}}_{0.05} \underbrace{10^{-1}}_{0.05} \underbrace{10^{-1}}_{0.05} \underbrace{10^{-1}}_{0.05} \underbrace{10^{-1}}_{0.05} \underbrace{10^{-1}}_{10^{-1}} \underbrace{10^{-1}}_{10^{-1}} \underbrace{10^{-1}}_{10^{-1}} \underbrace{10^{-1}}_{\text{tp}}(s)$										= 0.5	
$\begin{array}{c} 0.1 \\ 0.05 \\ 0.02 \\ 0.0$											
$\begin{array}{c} 0.1 \\ 0.05 \\ 0.02 \\ 0.0$										2	10-1
$10^{-2} \underbrace{0.02}_{10^{-3}} \underbrace{10^{-3}}_{10^{-6}} \underbrace{10^{-5}}_{10^{-5}} \underbrace{10^{-4}}_{10^{-4}} \underbrace{10^{-3}}_{10^{-3}} \underbrace{10^{-2}}_{10^{-2}} \underbrace{10^{-1}}_{t_{p}} (s)$										1	0:
$10^{-2} \underbrace{10^{-3}}_{10^{-6}} \underbrace{10^{-5}}_{10^{-5}} \underbrace{10^{-4}}_{10^{-4}} \underbrace{10^{-3}}_{10^{-3}} \underbrace{10^{-2}}_{10^{-1}} \underbrace{10^{-1}}_{t_{p}}(s)$										.05	0.0
$10^{-2} \qquad \qquad$		t <sub>o</sub>								.02	0:0
$10^{-3} \underbrace{10^{-3}}_{10^{-6}} \underbrace{10^{-5}}_{10^{-5}} \underbrace{10^{-4}}_{10^{-4}} \underbrace{10^{-3}}_{10^{-3}} \underbrace{10^{-2}}_{10^{-2}} \underbrace{10^{-1}}_{t_p}(s)$		$\delta = \frac{F}{T}$	_						single snot		10-2
$10^{-3} \underbrace{10^{-6}}_{10^{-6}} 10^{-5} 10^{-4} 10^{-3} 10^{-2} 10^{-1} \underbrace{10^{-1}}_{t_p}(s)$											
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$		   t	J_L ►  t <sub>o</sub>								
10 <sup>-6</sup> 10 <sup>-5</sup> 10 <sup>-4</sup> 10 <sup>-3</sup> 10 <sup>-2</sup> 10 <sup>-1</sup> t <sub>p</sub> (s)		•	, <b>−</b> T →								10-3
		(s) 1	t-	10 <sup>-1</sup>		10 <sup>-2</sup>	10 <sup>-3</sup>	10-4	10 <sup>-5</sup>	i	10-6
Fig. 4. Transient thermal impedance from junction to mounting base as a function of pulse duration											
		ion	e durati	n of puls	functio	ng base as a f	ction to mount	ce from junc	nermal impedance	ansient t	ig. 4. Tra
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				100					im		





ig. 6. PCB layout for thermal resistance junction to ambient minimum footprint;FR4 board; 2oz copper

#### **10. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
Static charac	cteristics	· · · · ·				
	drain-source	$I_D$ = 250 µA; $V_{GS}$ = 0 V; $T_j$ = 25 °C	30	-	-	V
	breakdown voltage	$I_D$ = 250 µA; $V_{GS}$ = 0 V; $T_j$ = -55 °C	27	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS}=V_{GS}; T_j = 25 \text{ °C}$	1.2	1.5	2.2	V

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Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
$\Delta V_{GS(th)} / \Delta T$	gate-source threshold voltage variation with temperature	25 °C ≤ T <sub>j</sub> ≤ 150 °C	-	-4.5	-	mV/K
I <sub>DSS</sub>	drain leakage current	$V_{DS}$ = 24 V; $V_{GS}$ = 0 V; $T_j$ = 25 °C	-	-	1	μA
		$V_{DS}$ = 24 V; $V_{GS}$ = 0 V; $T_j$ = 125 °C	-	3.7	-	μA
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = 16 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	100	nA
		$V_{GS}$ = -16 V; $V_{DS}$ = 0 V; $T_j$ = 25 °C	-	-	100	nA
$R_{DSon}$	drain-source on-state resistance	$V_{GS}$ = 4.5 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; Fig. 10	-	0.79	1.09	mΩ
		V <sub>GS</sub> = 4.5 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 150 °C; <u>Fig. 10</u> ; <u>Fig. 11</u>	-	-	1.8	mΩ
		V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 25 °C; <u>Fig. 10</u>	-	0.65	0.87	mΩ
	V <sub>GS</sub> = 10 V; I <sub>D</sub> = 25 A; T <sub>j</sub> = 150 °C; <u>Fig. 10; Fig. 11</u>	-	-	1.44	mΩ	
R <sub>G</sub>	gate resistance	f = 1 MHz	-	1.4	-	Ω
Dynamic ch	aracteristics	· · · ·				
Q <sub>G(tot)</sub> total gate charge	total gate charge	$I_D$ = 25 A; $V_{DS}$ = 15 V; $V_{GS}$ = 10 V; Fig. 12; Fig. 13	-	109	-	nC
		$I_D$ = 25 A; $V_{DS}$ = 15 V; $V_{GS}$ = 4.5 V; Fig. 12; Fig. 13	-	51	-	nC
	$I_D$ = 0 A; $V_{DS}$ = 0 V; $V_{GS}$ = 0 V	-	99	-	nC	
Q <sub>GS</sub>	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 15 \text{ V}; V_{GS} = 4.5 \text{ V};$	-	15.3	-	nC
Q <sub>GS(th)</sub>	pre-threshold gate- source charge	Fig. 12; Fig. 13	-	10.5	-	nC
Q <sub>GS(th-pl)</sub>	post-threshold gate- source charge		-	4.8	-	nC
Q <sub>GD</sub>	gate-drain charge		-	13.5	-	nC
V <sub>GS(pl)</sub>	gate-source plateau voltage	I <sub>D</sub> = 25 A; V <sub>DS</sub> = 15 V; <u>Fig. 12</u> ; <u>Fig. 13</u>	-	2.4	-	V
C <sub>iss</sub>	input capacitance	$V_{DS} = 15 \text{ V}; V_{GS} = 0 \text{ V}; \text{ f} = 1 \text{ MHz};$	-	7668	-	pF
C <sub>oss</sub>	output capacitance	T <sub>j</sub> = 25 °C; <u>Fig. 14</u>	-	2914	-	pF
C <sub>rss</sub>	reverse transfer capacitance		-	445	-	pF
t <sub>d(on)</sub>	turn-on delay time	$V_{DS}$ = 15 V; $R_L$ = 0.6 Ω; $V_{GS}$ = 4.5 V;	-	38.1	-	ns
t <sub>r</sub>	rise time	$R_{G(ext)} = 5 \Omega$	-	49.8	-	ns
t <sub>d(off)</sub>	turn-off delay time	]	-	63	-	ns
t <sub>f</sub>	fall time		-	42.6	-	ns
Q <sub>oss</sub>	output charge	$V_{GS}$ = 0 V; $V_{DS}$ = 15 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	83.11	-	nC
Source-drai	n diode	· · ·				
V <sub>SD</sub>	source-drain voltage	I <sub>S</sub> = 25 A; V <sub>GS</sub> = 0 V; T <sub>j</sub> = 25 °C; <u>Fig. 15</u>	-	0.76	1.2	V

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12 14 V<sub>GS</sub> (V) 16

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
t <sub>rr</sub>	reverse recovery time	$I_{\rm S}$ = 25 A; dI <sub>S</sub> /dt = -100 A/µs; V <sub>GS</sub> = 0 V;		-	52	-	ns
Qr	recovered charge	V <sub>DS</sub> = 15 V; <u>Fig. 16</u>	[1]	-	67	-	nC
t <sub>a</sub>	reverse recovery rise time	-		-	27.4	-	ns
t <sub>b</sub>	reverse recovery fall time			-	24.7	-	ns
S	softness factor			-	0.9	-	

6

4

3

2

1

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0

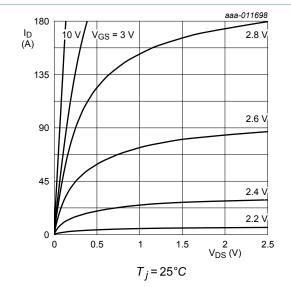
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4 6 8 10

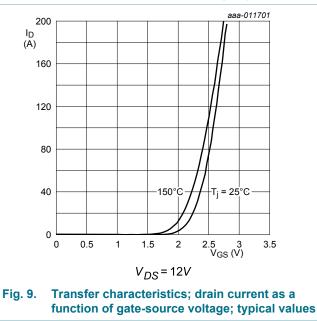
R<sub>DSon</sub>

(mΩ) 5

[1] includes capacitive recovery

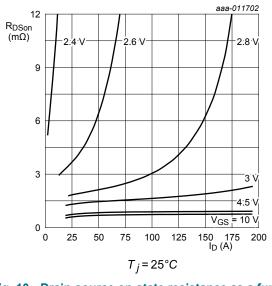








 $T_j = 25^{\circ}C; I_D = 25A$ 

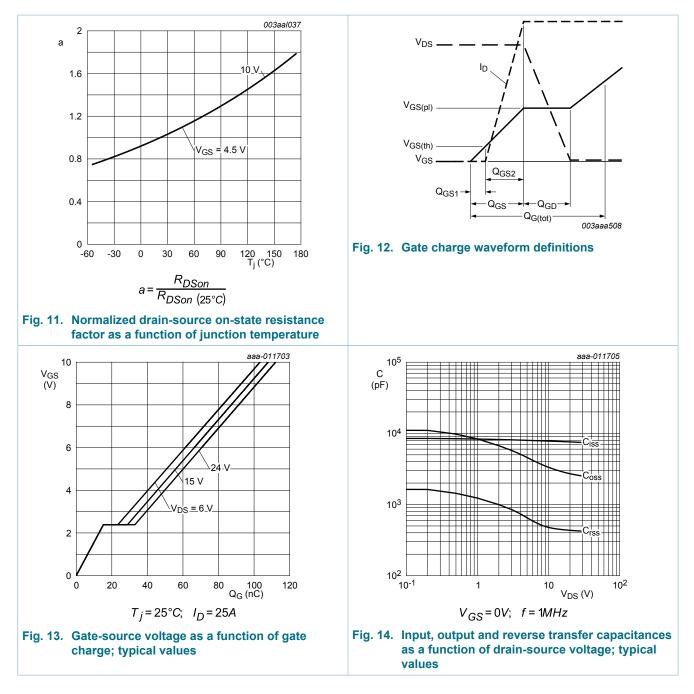




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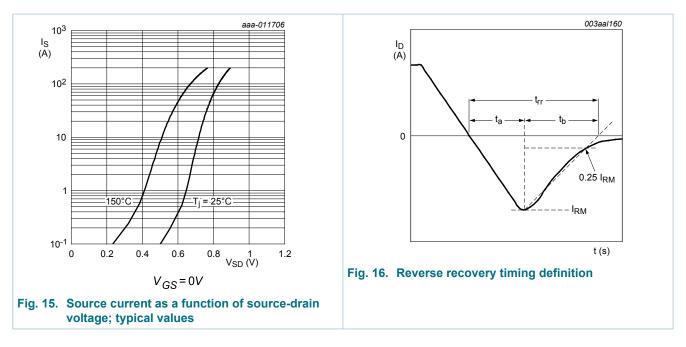
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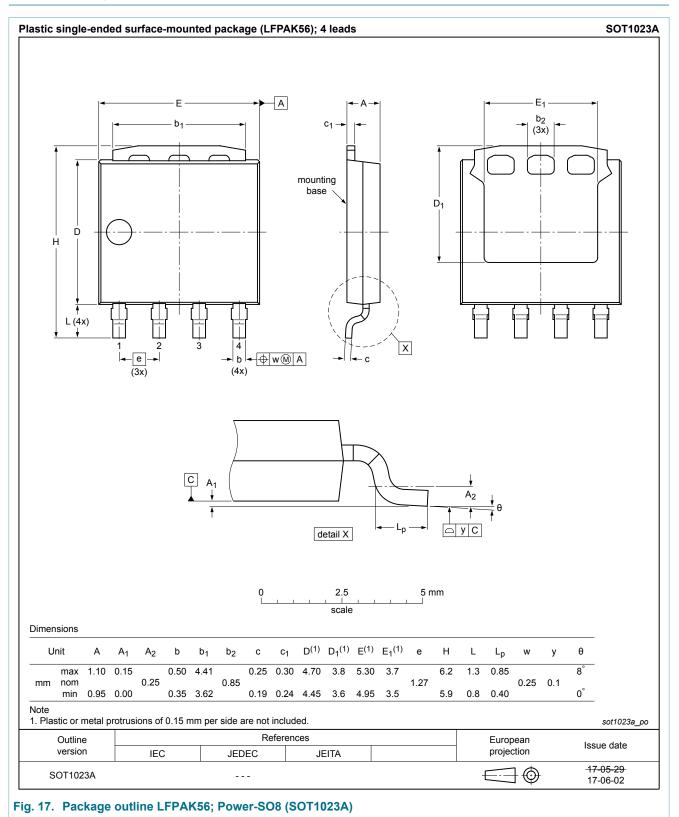


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#### 11. Package outline



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#### N-channel 30 V, 0.87 mΩ, 300 A logic level MOSFET in SOT1023A enhanced package for UL2595, using NextPowerS3 Schottky-Plus Technology

#### 12. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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N-channel 30 V, 0.87 mΩ, 300 A logic level MOSFET in SOT1023A enhanced package for UL2595, using NextPowerS3 Schottky-Plus Technology

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